



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



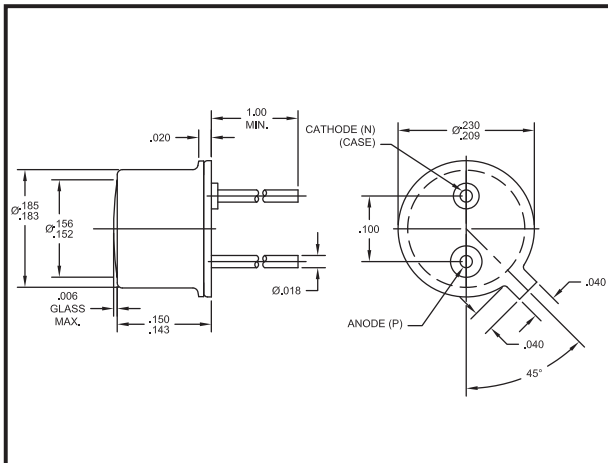
## Contact us

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**FEATURES**

- Extended operating temperature range
- No internal coatings
- No derating or heat sink required to 80°C
- Standard 2-lead TO-46 hermetic package

All surfaces are gold plated. Dimensions are nominal values in inches unless otherwise specified.

**ELECTRO-OPTICAL CHARACTERISTICS AT 25°C**

PARAMETERS	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Total Power Output, P <sub>O</sub>	I <sub>F</sub> = 100mA	19	26		mW
Peak Emission Wavelength, λ <sub>P</sub>	I <sub>F</sub> = 20mA		850		nm
Spectral Bandwidth at 50%, Δλ	I <sub>F</sub> = 20mA		40		nm
Half Intensity Beam Angle, θ	I <sub>F</sub> = 20mA		80		Deg
Forward Voltage, V <sub>F</sub>	I <sub>F</sub> = 100mA		1.6	2	Volts
Reverse Breakdown Voltage, V <sub>R</sub>	I <sub>R</sub> = 10μA	5	30		Volts
Rise Time	I <sub>FP</sub> = 20mA		20		nsec
Fall Time	I <sub>FP</sub> = 20mA		20		nsec

**ABSOLUTE MAXIMUM RATINGS AT 25°C CASE**

Power Dissipation <sup>1</sup>	200mW
Continuous Forward Current	100mA
Peak Forward Current (10μs, 200Hz) <sup>2</sup>	300mA
Reverse Voltage	5V
Lead Soldering Temperature (1/16" from case for 10sec)	260°C

<sup>1</sup>Derate per Thermal Derating Curve above 25°C

<sup>2</sup>Derate linearly above 25°C

**THERMAL PARAMETERS**

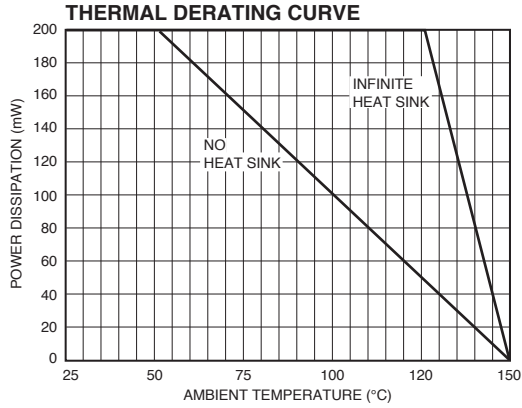
Storage and Operating Temperature Range	-65°C to 150°C
Maximum Junction Temperature	150°C
Thermal Resistance, R <sub>THJA</sub> <sup>1</sup>	400°C/W Typical
Thermal Resistance, R <sub>THJA</sub> <sup>2</sup>	135°C/W Typical

<sup>1</sup>Heat transfer minimized by measuring in still air with minimum heat conducting through leads

<sup>2</sup>Air circulating at a rapid rate to keep case temperature at 25°C



MAXIMUM RATINGS



TYPICAL CHARACTERISTICS

